



PBSS5220T

20 V, 2 A PNP low V_{CEsat} transistor

24 May 2022

Product data sheet

1. General description

PNP low V_{CEsat} transistor in a SOT23 small Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- AEC-Q101 qualified

3. Applications

- DC-to-DC conversion
- Supply line switching
- Battery charger
- LCD backlighting
- Driver in low supply voltage applications (e.g. lamps and LEDs)
- Inductive load driver (e.g. relays, buzzers and motors)

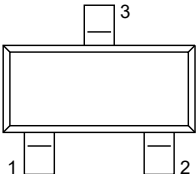
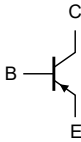
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	-20	V
I _C	collector current		-	-	-2	A
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	-	-3	A
R _{CEsat}	collector-emitter saturation resistance	I _C = -2 A; I _B = -200 mA; pulsed; t _p ≤ 300 μs; δ ≤ 0.02; T _{amb} = 25 °C	-	-	113	mΩ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 SOT23	 sym013
2	E	emitter		
3	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBSS5220T	SOT23	plastic, surface-mounted package; 3 terminals; 1.9 mm pitch; 2.9 mm x 1.3 mm x 1 mm body	SOT23

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PBSS5220T	% 3 F

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	-20	V
V _{CEO}	collector-emitter voltage	open base		-	-20	V
V _{EBO}	emitter-base voltage	open collector		-	-5	V
I _C	collector current			-	-2	A
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-3	A
I _B	base current			-	-300	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	300	mW
			[2]	-	480	mW
T _j	junction temperature			-	150	°C
T _{amb}	ambient temperature			-65	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	417	K/W
			[2]	-	-	260	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

10. Characteristics

Table 7. Characteristics

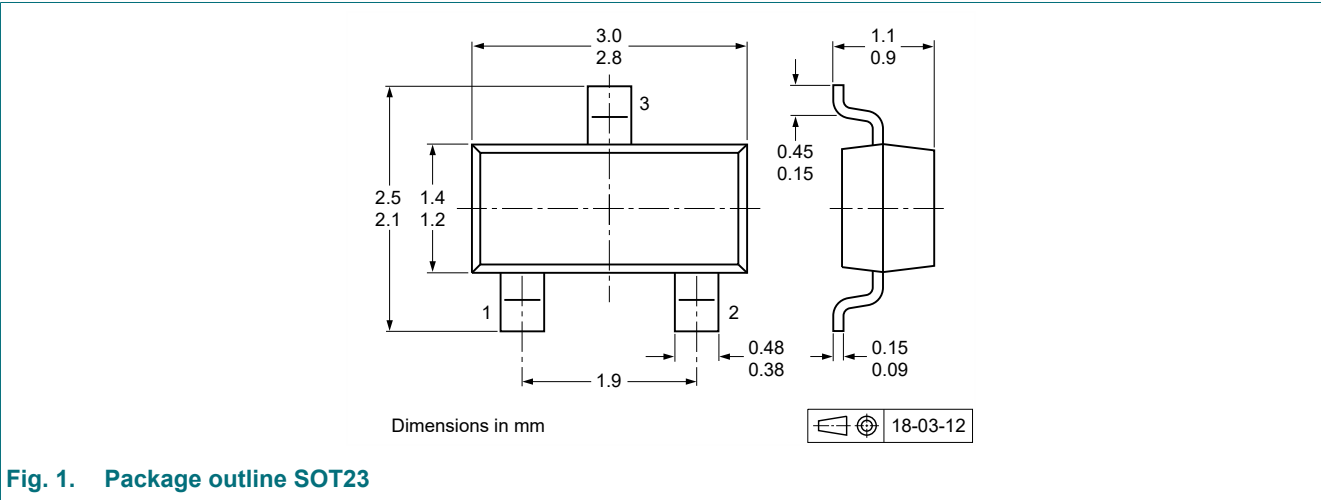
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{CBO}	collector-base cut-off current	$V_{CB} = -20\text{ V}$; $I_E = 0\text{ A}$; $T_{amb} = 25\text{ °C}$	-	-	-100	nA
		$V_{CB} = -20\text{ V}$; $I_E = 0\text{ A}$; $T_j = 150\text{ °C}$	-	-	-50	μA
I_{EBO}	emitter-base cut-off current	$V_{EB} = -5\text{ V}$; $I_C = 0\text{ A}$; $T_{amb} = 25\text{ °C}$	-	-	-100	nA
h_{FE}	DC current gain	$V_{CE} = -2\text{ V}$; $I_C = -100\text{ mA}$; $T_{amb} = 25\text{ °C}$	225	-	-	
		$V_{CE} = -2\text{ V}$; $I_C = -500\text{ mA}$; $T_{amb} = 25\text{ °C}$	225	-	-	
		$V_{CE} = -2\text{ V}$; $I_C = -1\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	200	-	-	
		$V_{CE} = -2\text{ V}$; $I_C = -2\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	150	-	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -500\text{ mA}$; $I_B = -50\text{ mA}$; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$; pulsed	-	-	-80	mV
		$I_C = -1\text{ A}$; $I_B = -50\text{ mA}$; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$; pulsed	-	-	-150	mV
		$I_C = -2\text{ A}$; $I_B = -100\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-	-250	mV
		$I_C = -2\text{ A}$; $I_B = -200\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-	-225	mV
R_{CEsat}	collector-emitter saturation resistance		-	-	113	mΩ
V_{BEsat}	base-emitter saturation voltage	$I_C = -2\text{ A}$; $I_B = -100\text{ mA}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-	-	-1.1	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2\text{ V}$; $I_C = -1\text{ A}$; pulsed; $t_p \leq 300\text{ μs}$; $\delta \leq 0.02$; $T_{amb} = 25\text{ °C}$	-1.2	-	-	V
f_T	transition frequency	$V_{CE} = -5\text{ V}$; $I_C = -100\text{ mA}$; $f = 100\text{ MHz}$; $T_{amb} = 25\text{ °C}$	100	-	-	MHz
C_c	collector capacitance	$V_{CB} = -10\text{ V}$; $I_E = 0\text{ A}$; $i_e = 0\text{ A}$; $f = 1\text{ MHz}$; $T_{amb} = 25\text{ °C}$	-	-	50	pF

11. Test information

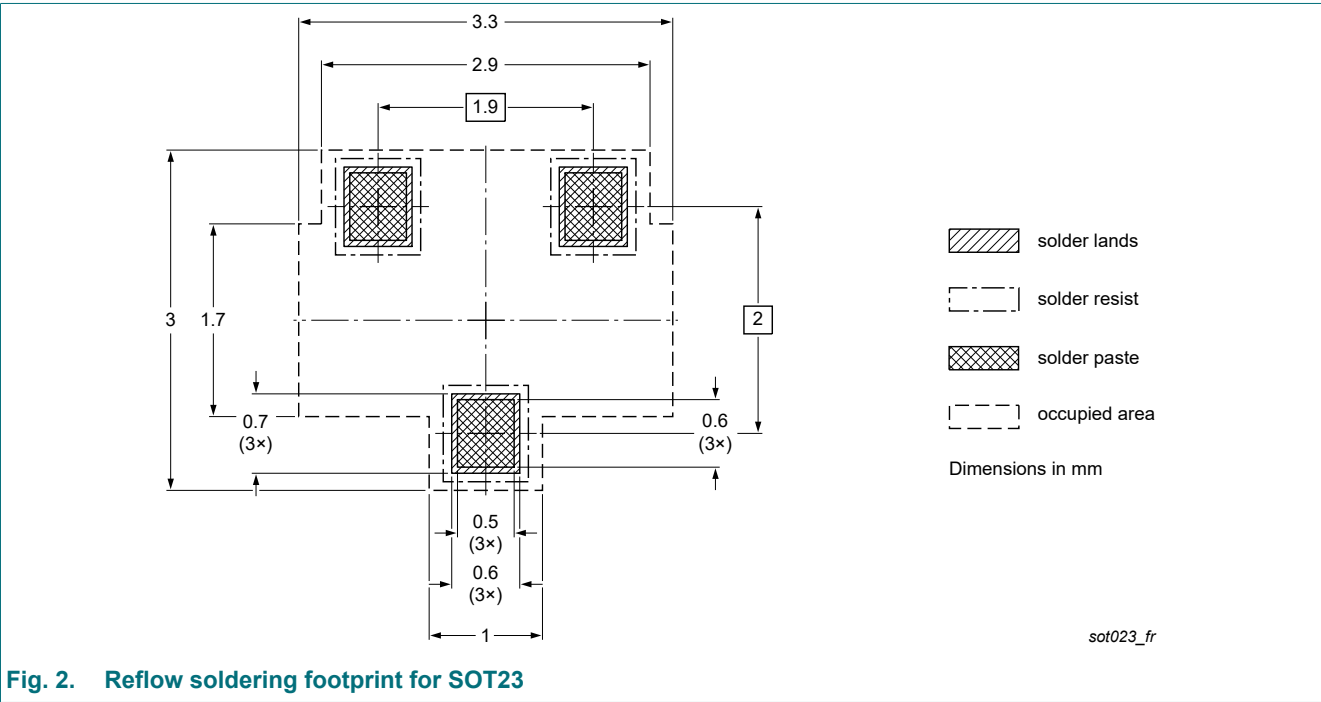
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering



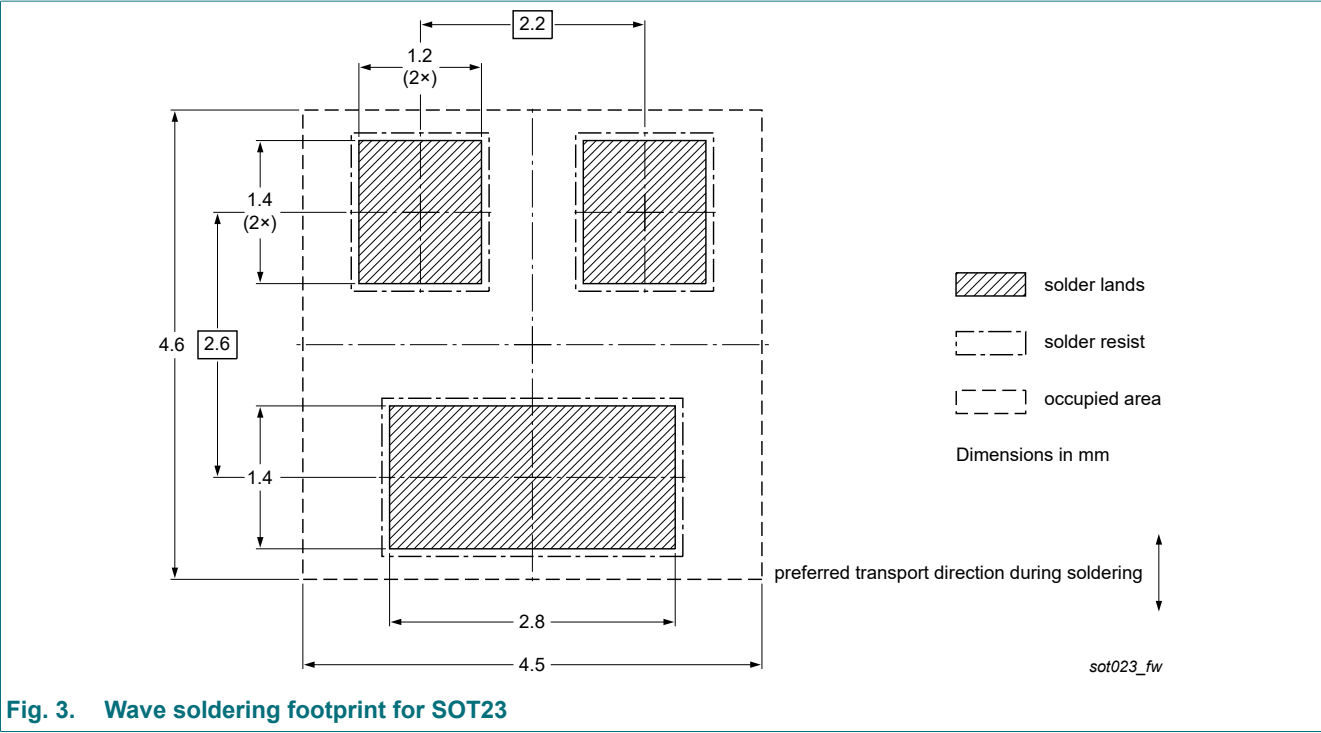


Fig. 3. Wave soldering footprint for SOT23

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS5220T v.2	20220524	Product data sheet	-	PBSS5220T v.1
Modifications:	<ul style="list-style-type: none">• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.• Legal texts have been adapted to the new company name where appropriate.• Marking code: corrected			
PBSS5220T v.1	20031218	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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Contents

1. General description..... 1

2. Features and benefits..... 1

3. Applications..... 1

4. Quick reference data..... 1

5. Pinning information..... 1

6. Ordering information..... 2

7. Marking..... 2

8. Limiting values..... 2

9. Thermal characteristics..... 2

10. Characteristics..... 3

11. Test information..... 3

12. Package outline..... 4

13. Soldering..... 4

14. Revision history..... 6

15. Legal information..... 7

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